

Pb RoHS

General Description

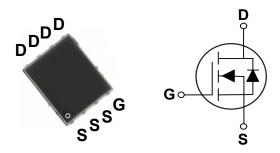
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV _{DSS}	R _{DS(ON)}	Ι _D
60 V	2 mΩ	140 A

Features

- $R_{DS(ON)} \leq 2m\Omega @V_{GS} = 10V$
- Fast Switching
- Improved dv/dt Capability
- Green Device Available

PPAK5X6 Pin Configuration



Applications

- Networking
- Load Switch
- LED Applications

Absolute Maximum Ratings T _c =25°C unless otherwise noted						
Symbol	Parameter	Rating	Units			
V _{DS}	Drain-Source Voltage	60	V			
V _{GS}	Gate-Source Voltage	±20	V			
۱ _D	Drain Current - Continuous (T _C =25°C)	140	А			
I _{DM}	Drain Current - Pulsed (NOTE 1)	560	А			
EAS	Single Pulse Avalanche Energy (NOTE 2)	423	mJ			
IAS	Single Pulse Avalanche Current (NOTE 2)	92	А			
P _D	Power Dissipation (T _C =25°C)	110	W			
TJ	Operating Junction Temperature Range	-55 to 150	°C			
T _{STG}	Storage Temperature Range	-55 to 150	°C			
Marking Code		NG2P0				

Thermal Characteristics

Symbol	Parameter		Max.	Unit	
R _{θJA}	Thermal Resistance Junction to Ambient		62	°C/W	
$R_{ ext{ ext{ ext{ ext{ ext{ ext{ ext{ ext$	Thermal Resistance Junction to Case		1.13	°C/W	





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics						
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	60			V
I _{DSS}	Drain-Source Leakage Current	V_{DS} =60V , V_{GS} =0V , T_{J} =25°C			1	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =20A			2	mΩ
		V _{GS} =4.5V , I _D =10A			3.2	
V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_{D}=250$ uA	1.2		2.5	V
gfs	Forward Transconductance	V _{DS} =10V , I _D =3A		15		S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Q_g	Total Gate Charge			98		
Q_gs	Gate-Source Charge	V _{DS} =30V , V _{GS} =10V , I _D =50A (NOTE 3 ∖ 4)		24		nC
Q_{gd}	Gate-Drain Charge	(NOTE 3 · 4)		27		
T _{d(on)}	Turn-On Delay Time	V _{DD} =30V , V _{GS} =10V , R _G =3.3Ω , I _D =1A (NOTE 3 \ 4)		19		
Tr	Rise Time			12		nS
T _{d(off)}	Turn-Off Delay Time			62		115
T _f	Fall Time			130		
C _{iss}	Input Capacitance	V _{DS} =30V , V _{GS} =0V , F=1MHz		4947		
C _{oss}	Output Capacitance			2850		pF
C _{rss}	Reverse Transfer Capacitance			26		
R_{g}	Gate resistance	V_{GS} =0V , V_{DS} =0V , F=1MHz		1.1		Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
۱ _s	Continuous Source Current	$V_{G}=V_{D}=0V$, Force Current			140	А
I _{SM}	Pulsed Source Current				280	А
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =1A , T _J =25°C			1	V

NOTES :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.

2. V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS}=92A, R_G=25 Ω , Starting T_J=25 $^{\circ}$ C.

3. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.

4. Essentially independent of operating temperature.



Characteristics Curves

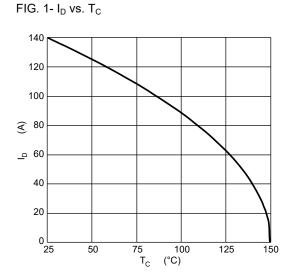


FIG. 3- Normalized $V_{GS(th)}\,vs.\;T_J$

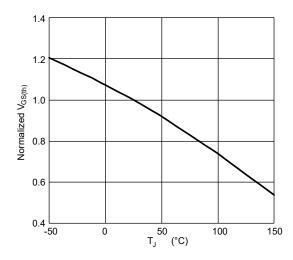


FIG. 5- Normalized Transient Impedance

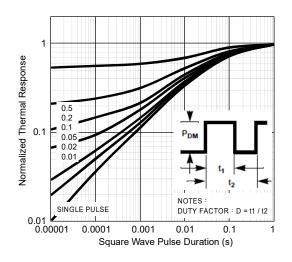


FIG. 2- Normalized $R_{DS(ON)}$ vs. T_J

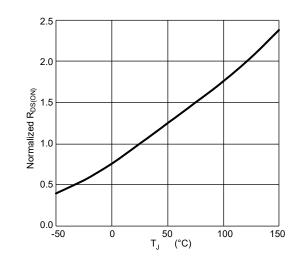


FIG. 4-Gate Charge Characteristics

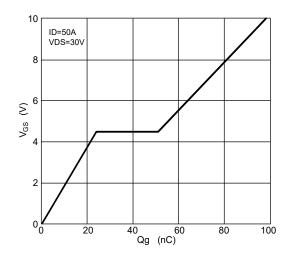
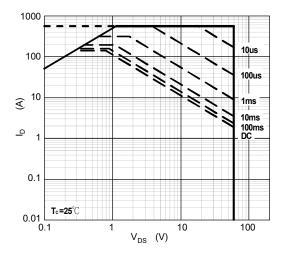


FIG. 6-Safe Operation Area







Characteristics Curves

FIG. 7- Switching Time Waveform

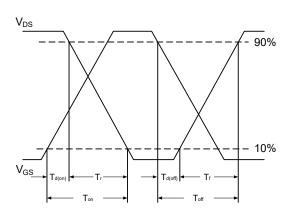
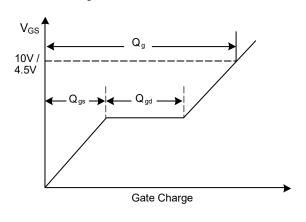
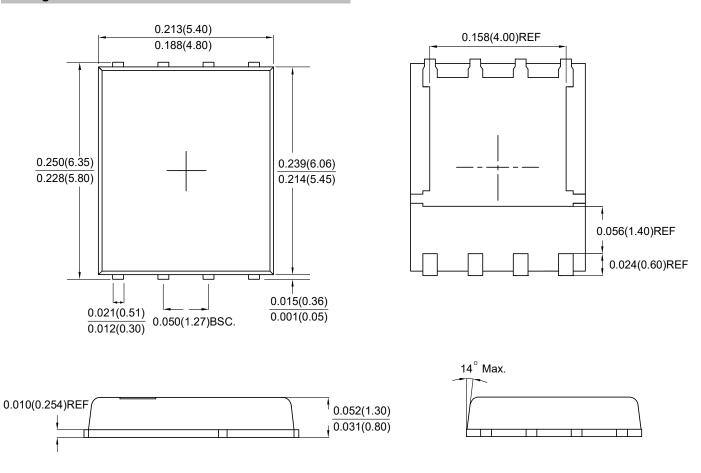


FIG. 8- Gate Charge Waveform



Package Outline Dimensions



PPAK5X6 Dimensions in inches and (millimeters)

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